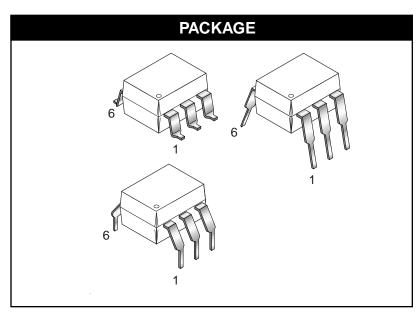
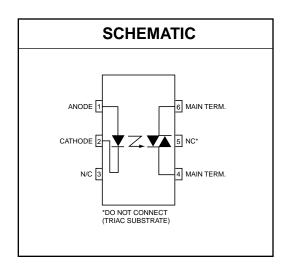


MOC3010M MOC3011M MOC3012M MOC3020M MOC3021M MOC3022M MOC3023M





DESCRIPTION

The MOC301XM and MOC302XM series are optically isolated triac driver devices. These devices contain a GaAs infrared emitting diode and a light activated silicon bilateral switch, which functions like a triac. They are designed for interfacing between electronic controls and power triacs to control resistive and inductive loads for 115 VAC operations.

FEATURES

- Excellent I_{FT} stability—IR emitting diode has low degradation
- High isolation voltage—minimum 5300 VAC RMS
- Underwriters Laboratory (UL) recognized—File #E90700
- · Peak blocking voltage
 - 250V-MOC301XM
 - 400V-MOC302XM
- VDE recognized (File #94766)
 - Ordering option V (e.g. MOC3023VM)

APPLICATIONS

- Industrial controls
- Traffic lights
- Vending machines
- Solid state relay
- Lamp ballasts
- · Solenoid/valve controls
- Static AC power switch
- Incandescent lamp dimmers
- Motor control



MOC3010M MOC3011M MOC3012M MOC3020M MOC3021M MOC3022M MOC3023M

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)						
Parameters	Symbol	Device	Value	Units		
TOTAL DEVICE						
Storage Temperature	T _{STG}	All	-40 to +150	°C		
Operating Temperature	T _{OPR}	All	-40 to +85	°C		
Lead Solder Temperature	T _{SOL}	All	260 for 10 sec	°C		
Junction Temperature Range	TJ	All	-40 to +100	°C		
Isolation Surge Voltage ⁽¹⁾ (peak AC voltage, 60Hz, 1 sec duration)	V _{ISO}	All	7500	Vac(pk)		
Total Device Power Dissipation @ 25°C	В	All	330	mW		
Derate above 25°C	P _D	All	4.4	mW/°C		
EMITTER						
Continuous Forward Current	I _F	All	60	mA		
Reverse Voltage	V _R	All	3	V		
Total Power Dissipation 25°C Ambient	В	All	100	mW		
Derate above 25°C	P _D	All	1.33	mW/°C		
DETECTOR						
Off-State Output Terminal Voltage	V _{DRM}	MOC3010M/1M/2M MOC3020M/1M/2M/3M	250 400	V		
Peak Repetitive Surge Current (PW = 1 ms, 120 pps)	I _{TSM}	All	1	Α		
Total Power Dissipation @ 25°C Ambient		All	300	mW		
Derate above 25°C	P _D	All	4	mW/°C		

Note

^{1.} Isolation surge voltage, V_{ISO}, is an internal device dielectric breakdown rating. For this test, Pins 1 and 2 are common, and Pins 4, 5 and 6 are common.



MOC3010M MOC3011M MOC3012M MOC3020M MOC3021M MOC3022M MOC3023M

ELECTRICAL CHARACTERISTICS (T_A = 25°C Unless otherwise specified)

INDIVIDUAL COMPONENT CHARACTERISTICS							
Parameters	Test Conditions	Symbol	Device	Min	Тур	Max	Units
EMITTER							
Input Forward Voltage	I _F = 10 mA	V _F	All		1.15	1.5	V
Reverse Leakage Current	V _R = 3 V, T _A = 25°C	I _R	All		0.01	100	μA
DETECTOR							
Peak Blocking Current, Either Direction	Rated V _{DRM} , I _F = 0 (note 1)	I _{DRM}	All		10	100	nA
Peak On-State Voltage, Either Direction	I _{TM} = 100 mA peak, I _F = 0	V_{TM}	All		1.8	3	V

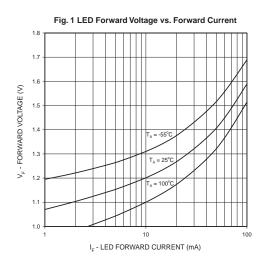
TRANSFER CHARACTERISTICS (T _A = 25°C Unless otherwise specified.)							
DC Characteristics	Test Conditions	Symbol	Device	Min	Тур	Max	Units
LED Trigger Current	Voltage = 3V (note 3)		MOC3020M			30	
			MOC3010M			15	
			MOC3021M			15	mA
		I _{FT}	MOC3011M			10 5	
			MOC3022M				
			MOC3012M				
			MOC3023M				
Holding Current, Either Direction		I _H	All		100		μA

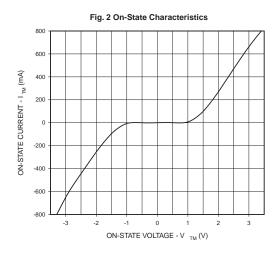
Note

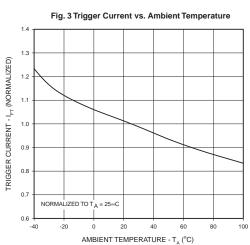
- 1. Test voltage must be applied within dv/dt rating.
- 2. This is static dv/dt. See Figure 5 for test circuit. Commutating dv/dt is a function of the load-driving thyristor(s) only.
- 3. All devices are guaranteed to trigger at an I_F value less than or equal to max I_{FT} . Therefore, recommended operating I_F lies between max I_{FT} (30 mA for MOC3020M, 15 mA for MOC3010M and MOC3021M, 10 mA for MOC3011M and MOC3022M, 5 mA for MOC3012M and MOC3023M) and absolute max I_F (60 mA).

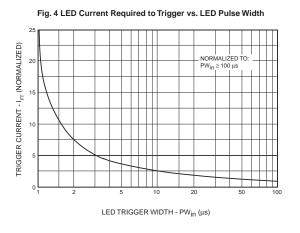


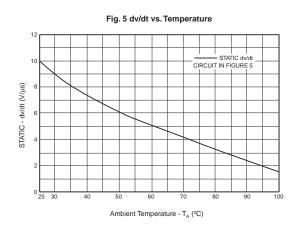
MOC3010M MOC3011M MOC3012M MOC3020M MOC3021M MOC3022M MOC3023M

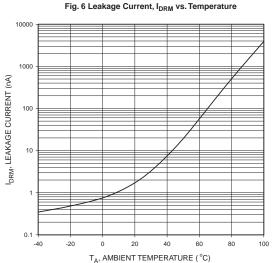






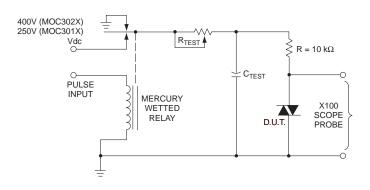








MOC3010M MOC3011M MOC3012M MOC3020M MOC3021M MOC3022M MOC3023M



- The mercury wetted relay provides a high speed repeated pulse to the D.U.T.
- 100x scope probes are used, to allow high speeds and voltages.
- 3. The worst-case condition for static dv/dt is established by triggering the D.U.T. with a normal LED input current, then removing the current. The variable R_{TEST} allows the dv/dt to be gradually increased until the D.U.T. continues to trigger in response to the applied voltage pulse, even after the LED current has been removed. The dv/dt is then decreased until the D.U.T. stops triggering. τ_{RC} is measured at this point and recorded.

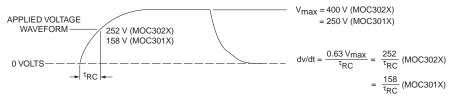


Figure 5. Static dv/dt Test Circuit

Note: This optoisolator should not be used to drive a load directly. It is intended to be a trigger device only.

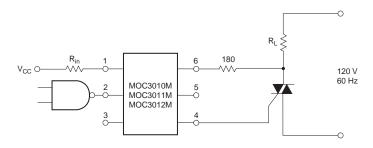


Figure 6. Resistive Load

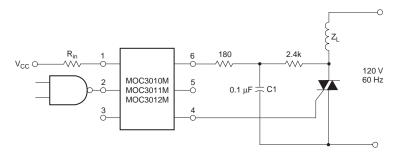


Figure 7. Inductive Load with Sensitive Gate Triac (I $_{GT} \leq$ 15 mA)



MOC3010M MOC3011M MOC3012M MOC3020M MOC3021M MOC3022M MOC3023M

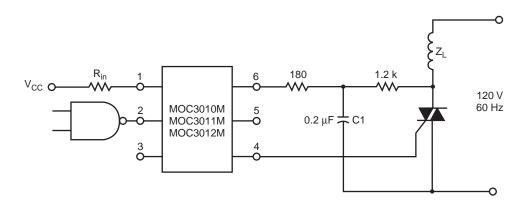
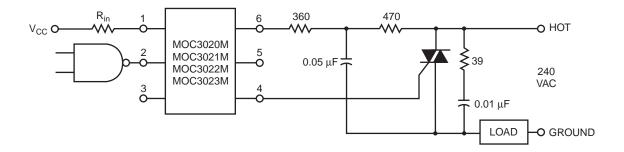


Figure 8. Inductive Load with Sensitive Gate Triac ($I_{GT} \le 15 \text{ mA}$)



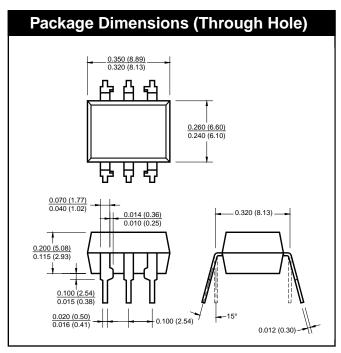
In this circuit the "hot" side of the line is switched and the load connected to the cold or ground side.

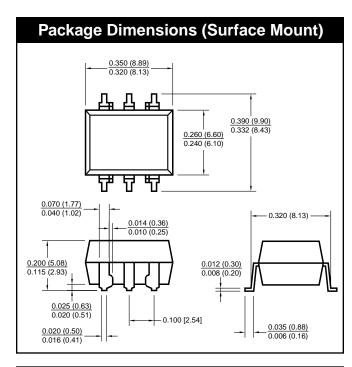
The 39 ohm resistor and $0.01\mu F$ capacitor are for snubbing of the triac, and the 470 ohm resistor and $0.05~\mu F$ capacitor are for snubbing the coupler. These components may or may not be necessary depending upon the particular and load used.

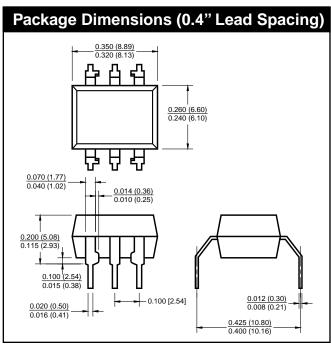
Figure 9. Typical Application Circuit

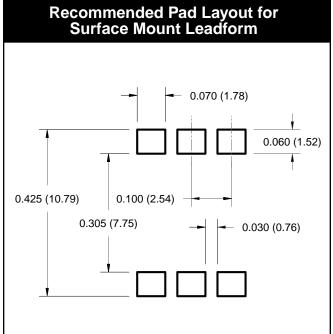


MOC3010M MOC3011M MOC3012M MOC3020M MOC3021M MOC3022M MOC3023M









NOTE

All dimensions are in inches (millimeters)

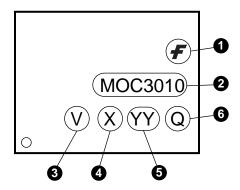


MOC3010M MOC3011M MOC3012M MOC3020M MOC3021M MOC3022M MOC3023M

ORDERING INFORMATION

Option	Order Entry Identifier	Description		
S	S	Surface Mount Lead Bend		
SR2	SR2	Surface Mount; Tape and reel		
Т	Т	0.4" Lead Spacing		
V	V	VDE 0884		
TV	TV	VDE 0884, 0.4" Lead Spacing		
SV	SV	VDE 0884, Surface Mount		
SR2V	SR2V	VDE 0884, Surface Mount, Tape & Reel		

MARKING INFORMATION

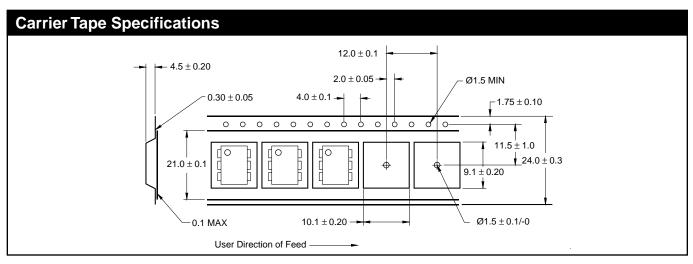


Definitions				
1	Fairchild logo			
2	Device number			
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)			
4	One digit year code, e.g., '3'			
5	Two digit work week ranging from '01' to '53'			
6	Assembly package code			

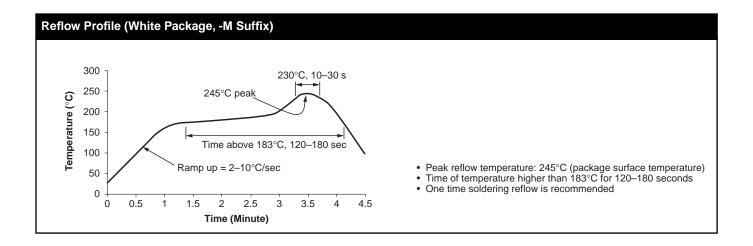
^{*}Note – Parts that do not have the 'V' option (see definition 3 above) that are marked with date code '325' or earlier are marked in portrait format.



MOC3010M MOC3011M MOC3012M MOC3020M MOC3021M MOC3022M MOC3023M



NOTEAll dimensions are in inches (millimeters)





MOC3010M MOC3011M MOC3012M MOC3020M MOC3021M MOC3022M MOC3023M

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.